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## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT			
NATURE OF CONVEYANCE:	ASSIGNMENT			

### **CONVEYING PARTY DATA**

Name	Execution Date
Chung-Tsung LU	07/30/2008
Pin-Chia SU	08/06/2008
Yu-Chih LIOU	07/30/2008

### **RECEIVING PARTY DATA**

Name:	Taiwan Semiconductor Manufacturing Co., Ltd.						
Street Address:	No. 8, Li-Hsin Rd. 6,						
Internal Address:	Science-Based Industrial Park						
City:	Hsin-Chu						
State/Country:	TAIWAN						
Postal Code:	300-77, R.O.C.						

Name:	Lam Research						
Street Address:	1650 Cushing Parkway						
City:	Fremont						
State/Country:	CALIFORNIA						
Postal Code:	94538						

### PROPERTY NUMBERS Total: 1

Property Type	Number					
Application Number:	12172669					

# CORRESPONDENCE DATA

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PATENT REEL: 021361 FRAME: 0074

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NAME OF SUBMITTER: Daniel R. McClure

Total Attachments: 2
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PATENT REEL: 021361 FRAME: 0075

### ASSIGNMENT

WHEREAS, Chung-Tsung LU, Pin-Chia SU and Yu-Chih LIOU hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: ME	THOD	AND	APP	ARATU	S FO	R SECUR	ELY	DECHUCKING	WAFERS		
Filed:								Serial No.			
Executed of	n: _J	uly	30,	2008	and	August	4,	2008			

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd. of No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C. and Lam Research of 4650 Cushing Parkway, Fremont, CA 94538, U.S.A hereinafter referred to as ASSIGNEES, are desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assigner further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignees expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

TSMC2008-0297/0503-A33774US

PATENT REEL: 021361 FRAME: 0076 IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Chung-Tsung Lu
Chung-Tsung Lu

7/40 2008 Date:

Par-Chia Su

Aug/4 - 108

Yu-Chih Liou Yu-Chih LIOU

730 / 2008.

Date: